

## **GIB Manufacturer's Instructions**

University of Pennsylvania – Dept Physics

**BOARD NAME: GPS Interface Board**

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## MANUFACTURING NOTES

1. This is a 8 layer board

Layer order:

1. TOP

2. GND1

3. PWR1

4 GND2

5. SIG

6. PWR2

7. GND3

8. BOTTOM

2. MATERIAL: FR4

3. BOARD THICKNESS: Approx. 0.060 inches – non-critical

4. COPPER THICKNESSES: ½ oz or best practice.

5. All holes are plated through unless otherwise noted

6. Smallest hole size 10mils

7. GOLD FINISH